



100V N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	RDS(ON) Max	I _D T _C = +25°C		
100V	9mΩ @ V _{GS} = 10V	84A		
	$14m\Omega$ @ VGS = 6V	66A		

Description and Applications

This MOSFET is designed to minimize the on-state resistance (R_{DS(ON)}) yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

- Motor Control
- Backlighting

TO251 (Type TH3)







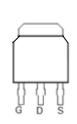
Bottom View

Features and Benefits

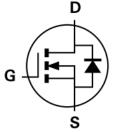
- Low On-Resistance
- Low Input Capacitance
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

Mechanical Data

- Case: TO251
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Terminal Connections: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.33 grams (Approximate)



Top View Pin Configuration



Internal Schematic

Ordering Information (Note 4)

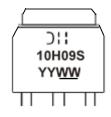
Part Number	Case	Packaging		
DMT10H9M9SH3	TO251 (Type TH3)	75 Pieces / Tube		

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information

TO251 (Type TH3)





Maximum Ratings (@ $T_A = +25$ °C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage	V _{DSS}	100	V	
Gate-Source Voltage	Vgss	±20	V	
Continuous Drain Current (Note 5) V _{GS} = 10V	$T_C = +25$ °C $T_C = +70$ °C	ID	84 67	Α
Maximum Body Diode Forward Current (Note 6)	Is	84	А	
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I _{DM}	336	Α	
Pulsed Body Diode Forward Current (10µs Pulse, T _C = +25°C, Packa	I _{SM}	336	А	
Avalanche Current, L = 3mH (Note 9)	I _{AS}	11	А	
Avalanche Energy, L = 3mH (Note 9)	Eas	181.5	mJ	

Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Total Dower Discipation (Note 5)	T _C = +25°C	0	114	W	
Total Power Dissipation (Note 5)	T _C = +70°C	PD	73	٧٧	
Thermal Resistance, Junction to Ambient (Note 6)	R _{0JA}	41	°C/W		
Thermal Resistance, Junction to Case (Note 5)	Rejc	1.1	C/VV		
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C	

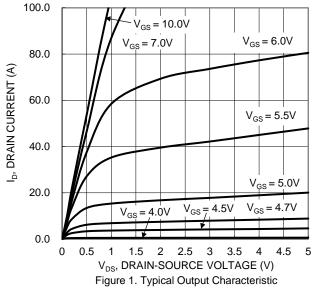
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

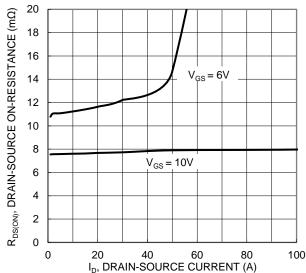
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)							
Drain-Source Breakdown Voltage	BVDSS	100	_		V	$V_{GS} = 0V$, $I_D = 1mA$	
Zero Gate Voltage Drain Current	I _{DSS}	_	_	1	μA	V _{DS} = 80V, V _{GS} = 0V	
Gate-Source Leakage	Igss	_	_	100	nA	Vgs = ±20V, Vps = 0V	
ON CHARACTERISTICS (Note 8)	ON CHARACTERISTICS (Note 8)						
Gate Threshold Voltage	V _{GS(TH)}	2	_	4	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$	
Static Drain-Source On-Resistance	Descent	_	7.4	9	mΩ	V _{GS} = 10V, I _D = 20A	
Static Drain-Source On-Resistance	R _{DS(ON)}	_	10.9	14	mΩ	$V_{GS} = 6V$, $I_D = 5A$	
Diode Forward Voltage	VsD	_	0.8	1.2	V	V _G S = 0V, I _S = 13A	
DYNAMIC CHARACTERISTICS (Note 7)	•				•		
Input Capacitance	Ciss		2085	_		V _{DS} = 50V, V _{GS} = 0V f = 1MHz	
Output Capacitance	Coss		609	_	pF		
Reverse Transfer Capacitance	Crss		13	_		I = IIVIAZ	
Gate Resistance	Rg	_	1.7	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge	Qg	_	30	_		V 50V L 40A	
Gate-Source Charge	Qgs	_	9.5	_	nC	$V_{DD} = 50V, I_D = 13A,$ $V_{GS} = 10V$	
Gate-Drain Charge	Q_{gd}	_	7.3	_		VGS = 10V	
Turn-On Delay Time	t _{D(ON)}	_	9.7	_		$V_{DD} = 50V, V_{GS} = 10V,$ $I_{D} = 13A, R_{G} = 6\Omega$	
Turn-On Rise Time	t _R		13.7	_			
Turn-Off Delay Time	tD(OFF)	_	25.1	_	ns		
Turn-Off Fall Time	tF	1	17.3	_			
Reverse Recovery Time	t _{RR}	_	45	_	ns	L 124 di/dt 1004/va	
Reverse Recovery Charge	Qrr		68	_	nC	I _F = 13A, di/dt = 100A/μs	

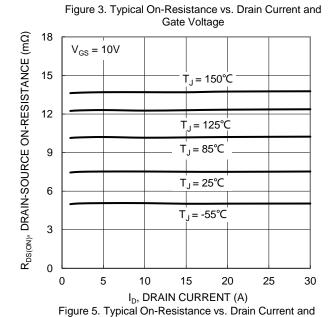
Notes:

- 5. Device mounted on infinite heatsink.
- 6. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
- 7. Guaranteed by design. Not subject to production testing.
- 8. Short duration pulse test used to minimize self-heating effect.
- 9. It depends on limited duration repetitive pulse and duty cycle, and limited by junction temperature $T_{J(MAX)} = +125^{\circ}C$.

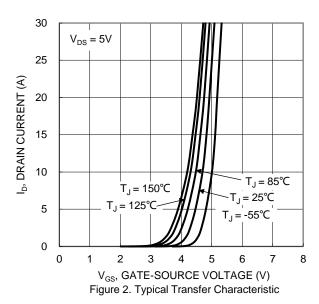


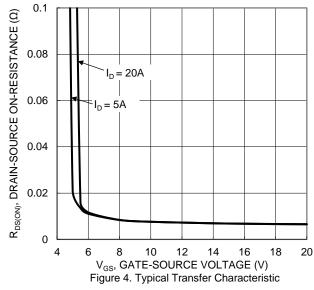






Junction Temperature





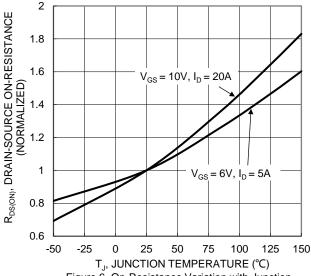


Figure 6. On-Resistance Variation with Junction Temperature



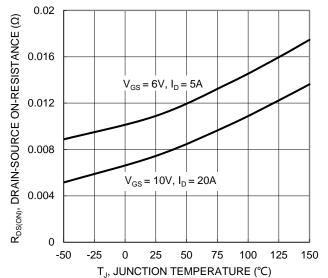
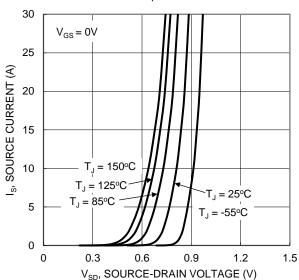


Figure 7. On-Resistance Variation with Junction Temperature



V_{SD}, SOURCE-DRAIN VOLTAGE (V) Figure 9. Diode Forward Voltage vs. Current

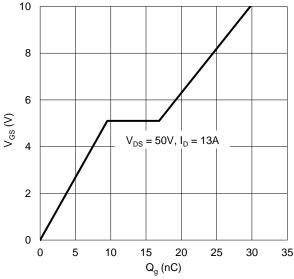


Figure 11. Gate Charge

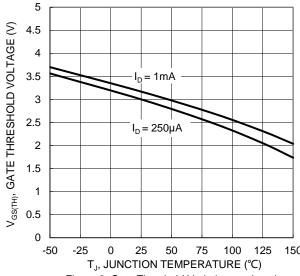
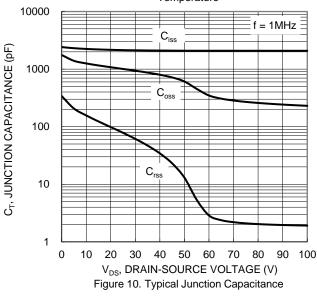


Figure 8. Gate Threshold Variation vs. Junction Temperature



1000 R_{DS(ON)} 100 ID, DRAIN CURRENT (A) 10 T_C = 25°C Single Pulse DUT on Infinite Heatsink $V_{GS} = 10V$ 0.01 0.1 10 100 1000 V_{DS}, DRAIN-SOURCE VOLTAGE (V) Figure 12. SOA, Safe Operation Area



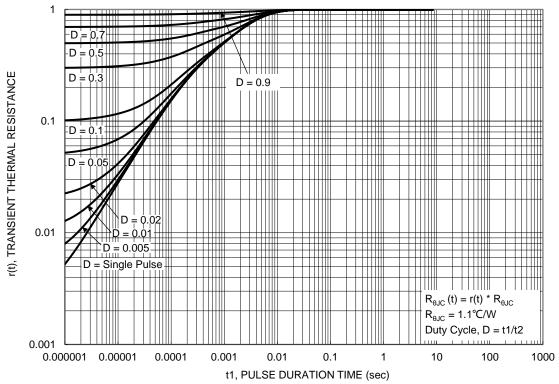
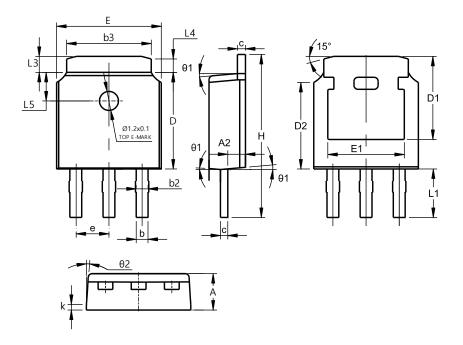


Figure 13. Transient Thermal Resistance



Package Outline Dimensions

TO251 (Type TH3)



TO251 (Type TH3)						
Dim	Min Max Typ					
Α	2.20	2.40	2.30			
A2	0.97	1.17	1.07			
b	0.68	0.90	0.78			
b2	0.76	0.95	0.84			
b3	5.20	5.50	5.33			
С	0.43	0.63	0.53			
D	5.98	6.22	6.10			
D1	5	.30 RE	F			
D2	5.26	5.66	5.46			
е	2.	286 BS	C			
Е	6.40	6.80	6.60			
E1	4.63	5.03	4.83			
Н	9.40	9.85	9.62			
k	().40REI	F			
L1	2.30	2.70	2.50			
L3	0.88	1.28	1.02			
L4	0.75 REF					
L5	1.65	1.95	1.80			
θ1	5°	9°	7°			
θ2	5°	9°	7°			
All Dimensions in mm						



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